

Thermal Grease



Features:

1. Excellent wet-out properties and low flowability, effectively filling uneven gaps.
2. Minimal interfacial thickness and low thermal impedance.
3. No preheating required, suitable for manual coating or screen printing.

Applications:

Filling gaps between CPUs, GPUs, and heatsinks.

Model	Thermal Impedance, °C*in ² /W at 30psi	Thermal Conductivity W/m·K	Minimal Interfacial Thickness, mm	Viscosity, Pa·s, at 25°C	Density, g/cm ³	Operating Temp., °C
JSSG-0560-10	0.04	1.0	0.05	150	2.0	-50~150
JSSG-0560-20	0.035	2.0	0.05	200	2.2	-50~150
JSSG-0560-30	0.02	3.0	0.05	240	2.5	-50~150
JSSG-0560-40	0.017	4.0	0.05	350	2.6	-50~150
JSSG-0560-50	0.015	5.0	0.05	400	2.8	-50~150